# TOSHIBA

TOSHIBA Photocoupler Photorelay

**TLP222G, TLP222G-2** 

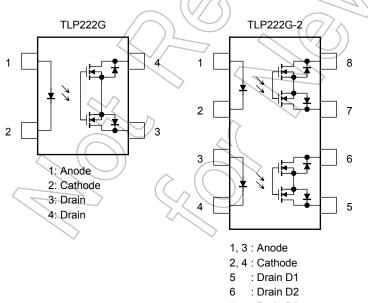
Cordless Telephones PBX Modems

The Toshiba TLP222G series consist of an infrared emitting diode optically coupled to a photo-MOSFET in a DIP package.

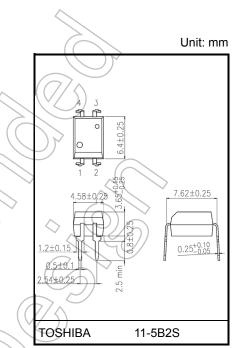
The TLP222G series are a bi-directional switch, which can replace mechanical relays in many applications.

- TLP222G: 4-pin DIP (DIP4), 1-channel type (1-form-A)
- TLP222G-2: 8-pin DIP (DIP8), 2-channel type (2-form-A)
- Peak Off-state voltage: 350 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance:  $35 \Omega$  (max, t < 1 s)
- On-state resistance: 50  $\Omega$  (max, continuous)
- Isolation voltage: 2500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

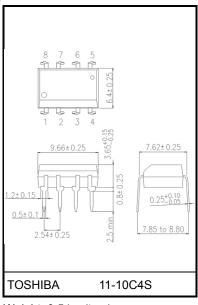
### Pin Configuration (top view)



7 : Drain D3 8 : Drain D4



Weight: 0.26 g (typ.)



Weight: 0.54 g (typ.)

Start of commercial production 2001-12

#### Absolute Maximum Rating (Ta = 25°C)

	(	Characteristics	3	Symbol	Rating	Unit	
	Forward current			lF	50	mA	
LED	Forward current derating (Ta $\ge$ 25°C)			∆l <sub>F</sub> /°C	-0.5	mA/°C	
	Peak forward	d current (10	0 μs pulse, 100 pps)	IFP	1	А	
	Reverse volt	age		VR	5	×	
	Diode power	dissipation		PD	50	mW	
	Diode power	dissipation d	erating (Ta ≥ 25°C)	∆P <sub>D</sub> /°C	-0.5	mW/°C	$\sum$
	Junction temperature			Tj	125	°C	
	Off-state out	put terminal v	oltage	Voff	350	((N))	
	On-state current	TLP222G					
		TLP222G-2	One channel operation	I <sub>ON</sub>	120	mA	
			Two channel operations				
Detector	On-state	TLP222G	1				
Detector	current derating (Ta ≥ 25°C)	TLP222G-2	One channel operation	∆lon/°C	1.2	mA/°C	6
			Two channel operations				540)
	Output powe	r dissipation		Po	450	mW	
	Output powe	r dissipation of	derating (Ta ≥ 25°C)	ΔP <sub>o</sub> /°C	-4.5	mW1°C	)
	Junction tem	perature	(		125	<b>℃</b>	
Storage to	emperature ra	inge	G	T <sub>stg</sub>	-55 to 125	°C)	
Operating	Operating temperature range				-40 to 85	°C	
Lead sold	lering tempera	ature (10 s)		T <sub>sol</sub>	260	°C	
Isolation	voltage (AC, 6	60 s, R.H. ≤ 60	0 %) (Note 1)	BVS	2500	Vrms	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	—	_	280	V
Forward current	C IF	5	7.5	25	mA
On-state current	ION	—	—	100	mA
Operating temperature	Topr	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

### **Electrical Characteristics (Ta = 25°C)**

	Characteristics		Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	IF = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	$V_R = 5 V$	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz	_	30	_	pF
Detector	Off-state current	loff	Voff = 350 V	_	_	1	μA
	Capacitance	COFF	V = 0 V, f = 1 MHz		30	_	рF

Note 1: Device considered a two-terminal device: LED side pins shorted together and detector side pins shorted together.

### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	IFT	I <sub>ON</sub> = 120 mA	_	1	3	mA
Return LED current	IFC	$I_{OFF} = 100 \ \mu A$	0.1	—		mA
		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, t < 1 s	χ	25	35	
On-state resistance	R <sub>ON</sub>	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA, continuous (Note)		35	50	Ω

Note : Continuous means a state of thermally saturated.

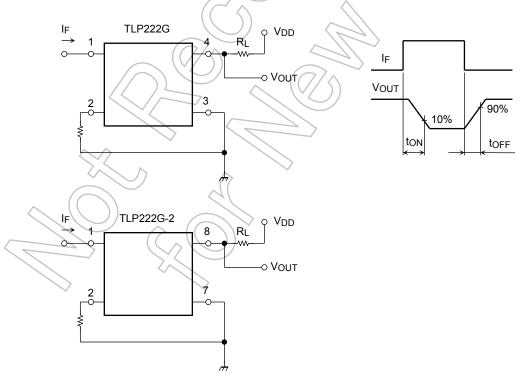
### Isolation Characteristics (Ta = 25°C)

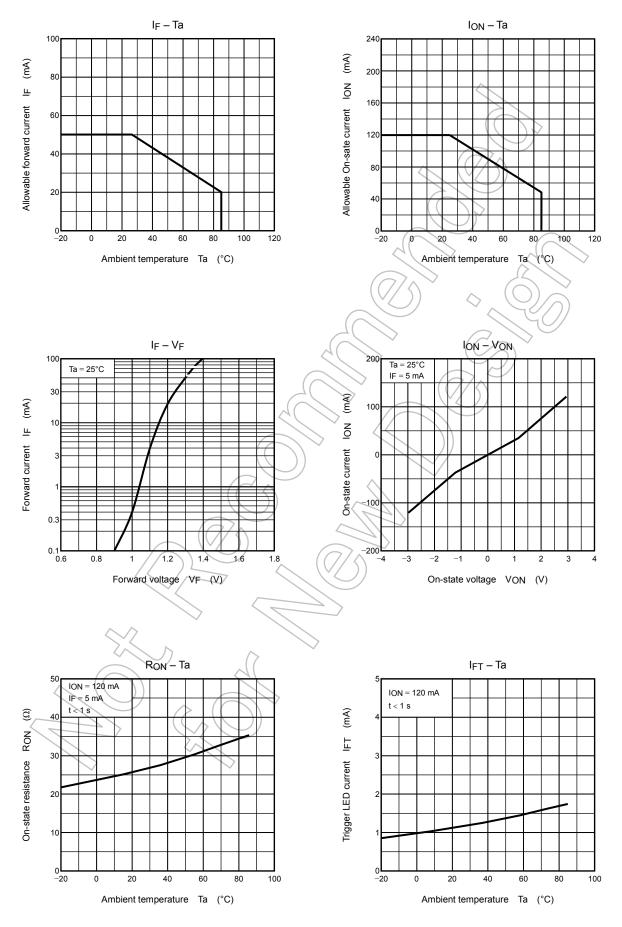
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> = 0 V, f = 1 MHz	—	0.8	4	pF
Isolation resistance	Rs	Vs = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>		Ω
Isolation voltage	BVs	AC, 60 s	2500			Vrms

### Switching Characteristics (Ta = 25°C)

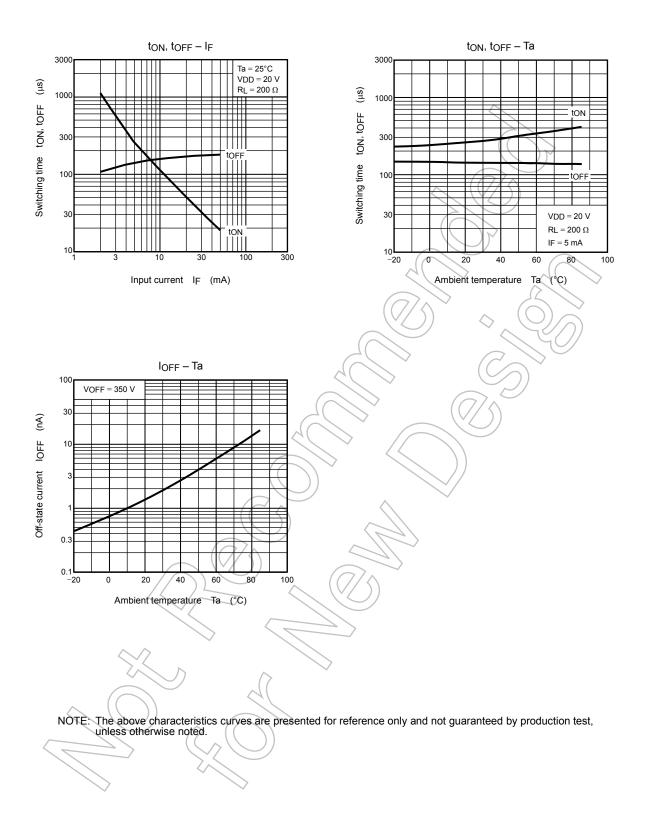
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	RL = 200 Ω		0.3	1	ms
Turn-off time	toff	$V_{DD} = 20 \text{ V}, \text{ I}_{\text{F}} = 5 \text{ mA}$ (Note)	_	0.1	1	1115

#### Note : Switching time test circuit





NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



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